



High power cycling capability  
Low on-state and switching losses  
Designed for traction and industrial applications

## Phase Control Thyristor Type T153-800-18

Mean on-state current			I <sub>TAV</sub>	800 A				
Repetitive peak off-state voltage			V <sub>DRM</sub>	1000 ÷ 1800 V				
Repetitive peak reverse voltage			V <sub>RRM</sub>					
Turn-off time			t <sub>q</sub>	200, 250, 320, 400, 500 µs				
V <sub>DRM</sub> , V <sub>RRM</sub> , V	1000	1100	1200	1300	1400	1500	1600	1800
Voltage code	10	11	12	13	14	15	16	18
T <sub>j</sub> , °C	-60 ÷ 125							

### MAXIMUM ALLOWABLE RATINGS

Symbols and parameters			Units	Values	Test conditions	
<b>ON-STATE</b>						
I <sub>TAV</sub>	Mean on-state current	A	800 1360	T <sub>c</sub> =105 °C, Double side cooled T <sub>c</sub> =85 °C, Double side cooled 180° half-sine wave; 50 Hz		
I <sub>TRMS</sub>	RMS on-state current	A	1256	T <sub>c</sub> =105 °C, Double side cooled 180° half-sine wave; 50 Hz		
I <sub>TSM</sub>	Surge on-state current	kA	29.0 33.0	T <sub>j</sub> =T <sub>j</sub> max T <sub>j</sub> =25 °C	180° half-sine wave; t <sub>p</sub> =10 ms; single pulse; V <sub>D</sub> =V <sub>R</sub> =0 V; Gate pulse: I <sub>G</sub> =2 A; t <sub>GP</sub> =50 µs; di <sub>G</sub> /dt≥1 A/µs	
			30.0 35.0	T <sub>j</sub> =T <sub>j</sub> max T <sub>j</sub> =25 °C	180° half-sine wave; t <sub>p</sub> =8.3 ms; single pulse; V <sub>D</sub> =V <sub>R</sub> =0 V; Gate pulse: I <sub>G</sub> =2 A; t <sub>GP</sub> =50 µs; di <sub>G</sub> /dt≥1 A/µs	
I <sup>2</sup> t	Safety factor	A <sup>2</sup> ·10 <sup>3</sup>	4200 5400	T <sub>j</sub> =T <sub>j</sub> max T <sub>j</sub> =25 °C	180° half-sine wave; t <sub>p</sub> =10 ms; single pulse; V <sub>D</sub> =V <sub>R</sub> =0 V; Gate pulse: I <sub>G</sub> =2 A; t <sub>GP</sub> =50 µs; di <sub>G</sub> /dt≥1 A/µs	
			3700 5000	T <sub>j</sub> =T <sub>j</sub> max T <sub>j</sub> =25 °C	180° half-sine wave; t <sub>p</sub> =8.3 ms; single pulse; V <sub>D</sub> =V <sub>R</sub> =0 V; Gate pulse: I <sub>G</sub> =2 A; t <sub>GP</sub> =50 µs; di <sub>G</sub> /dt≥1 A/µs	
<b>BLOCKING</b>						
V <sub>DRM</sub> , V <sub>RRM</sub>	Repetitive peak off-state and Repetitive peak reverse voltages	V	1000÷1800	T <sub>j min</sub> < T <sub>j </sub> <T <sub>j max</sub> ; 180° half-sine wave; 50 Hz; Gate open		
V <sub>DSM</sub> , V <sub>RSM</sub>	Non-repetitive peak off-state and Non-repetitive peak reverse voltages	V	1100÷1900	T <sub>j min</sub> < T <sub>j </sub> <T <sub>j max</sub> ; 180° half-sine wave; single pulse; Gate open		
V <sub>D</sub> , V <sub>R</sub>	Direct off-state and Direct reverse voltages	V	0.6V <sub>DRM</sub> 0.6V <sub>RRM</sub>	T <sub>j</sub> =T <sub>j</sub> max; Gate open		

TRIGGERING				
$I_{FGM}$	Peak forward gate current	A	8	$T_j=T_{j \max}$
$V_{RGM}$	Peak reverse gate voltage	V	5	
$P_G$	Gate power dissipation	W	4	$T_j=T_{j \max}$ for DC gate current
SWITCHING				
$(di_T/dt)_{crit}$	Critical rate of rise of on-state current non-repetitive ( $f=1$ Hz)	A/ $\mu$ s	2000	$T_j=T_{j \max}$ ; $V_D=0.67V_{DRM}$ ; $I_{TM}=4000$ A; Gate pulse: $I_G=2$ A; $t_{GP}=50$ $\mu$ s; $di_G/dt \geq 2$ A/ $\mu$ s
THERMAL				
$T_{stg}$	Storage temperature	°C	-60÷50	
$T_j$	Operating junction temperature	°C	-60÷125	
MECHANICAL				
F	Mounting force	kN	24.0÷28.0	
a	Acceleration	m/s <sup>2</sup>	50	Device clamped

## CHARACTERISTICS

Symbols and parameters		Units	Values	Conditions
ON-STATE				
$V_{TM}$	Peak on-state voltage, max	V	1.45	$T_j=25$ °C; $I_{TM}=2512$ A
$V_{T(TO)}$	On-state threshold voltage, max	V	0.958	$T_j=T_{j \max}$ ;
$r_T$	On-state slope resistance, max	$m\Omega$	0.203	$0.5 \pi I_{TAV} < I_T < 1.5 \pi I_{TAV}$
$I_L$	Latching current, max	mA	1500	$T_j=25$ °C; $V_D=12$ V; Gate pulse: $I_G=2$ A; $t_{GP}=50$ $\mu$ s; $di_G/dt \geq 1$ A/ $\mu$ s
$I_H$	Holding current, max	mA	300	$T_j=25$ °C; $V_D=12$ V; Gate open
BLOCKING				
$I_{DRM}, I_{RRM}$	Repetitive peak off-state and Repetitive peak reverse currents, max	mA	150	$T_j=T_{j \max}$ ; $V_D=V_{DRM}$ ; $V_R=V_{RRM}$
$(dv_D/dt)_{crit}$	Critical rate of rise of off-state voltage <sup>1)</sup> , min	V/ $\mu$ s	200, 320, 500, 1000, 1600, 2000, 2500	$T_j=T_{j \max}$ ; $V_D=0.67V_{DRM}$ ; Gate open
TRIGGERING				
$V_{GT}$	Gate trigger direct voltage, max	V	3.00 2.50 1.50	$T_j=T_{j \min}$ $T_j=25$ °C $T_j=T_{j \max}$
$I_{GT}$	Gate trigger direct current, max	mA	400 250 150	$T_j=T_{j \min}$ $T_j=25$ °C $T_j=T_{j \max}$
$V_{GD}$	Gate non-trigger direct voltage, min	V	0.45	$T_j=T_{j \max}$ ;
$I_{GD}$	Gate non-trigger direct current, min	mA	50.00	$V_D=0.67V_{DRM}$ ; Direct gate current
SWITCHING				
$t_{gd}$	Delay time	$\mu$ s	0.75	$T_j=25$ °C; $V_D=1000$ V; $I_{TM}=I_{TAV}$ ;
$t_{gt}$	Turn-on time, max	$\mu$ s	4.00	$di/dt=200$ A/ $\mu$ s; Gate pulse: $I_G=2$ A; $V_G=20$ V; $t_{GP}=50$ $\mu$ s; $di_G/dt=2$ A/ $\mu$ s
$t_q$	Turn-off time <sup>2)</sup> , max	$\mu$ s	200, 250, 320, 400, 500	$dv_D/dt=50$ V/ $\mu$ s; $T_j=T_{j \max}$ ; $I_{TM}=I_{TAV}$ ; $di_R/dt=-10$ A/ $\mu$ s; $V_R=100$ V; $V_D=0.67V_{DRM}$
$Q_{rr}$	Total recovered charge, max	$\mu$ C	2700	$T_j=T_{j \max}$ ; $I_{TM}=I_{TAV}$ ;
$t_{rr}$	Reverse recovery time, typ	$\mu$ s	30	$di_R/dt=-10$ A/ $\mu$ s;
$I_{rrM}$	Peak reverse recovery current, max	A	180	$V_R=100$ V;

THERMAL						
$R_{thjc}$	Thermal resistance, junction to case, max		$^{\circ}\text{C}/\text{W}$	0.0180	Direct current	Double side cooled
$R_{thjc-A}$				0.0396		Anode side cooled
$R_{thjc-K}$				0.0324		Cathode side cooled
$R_{thck}$	Thermal resistance, case to heatsink, max		$^{\circ}\text{C}/\text{W}$	0.0040	Direct current	

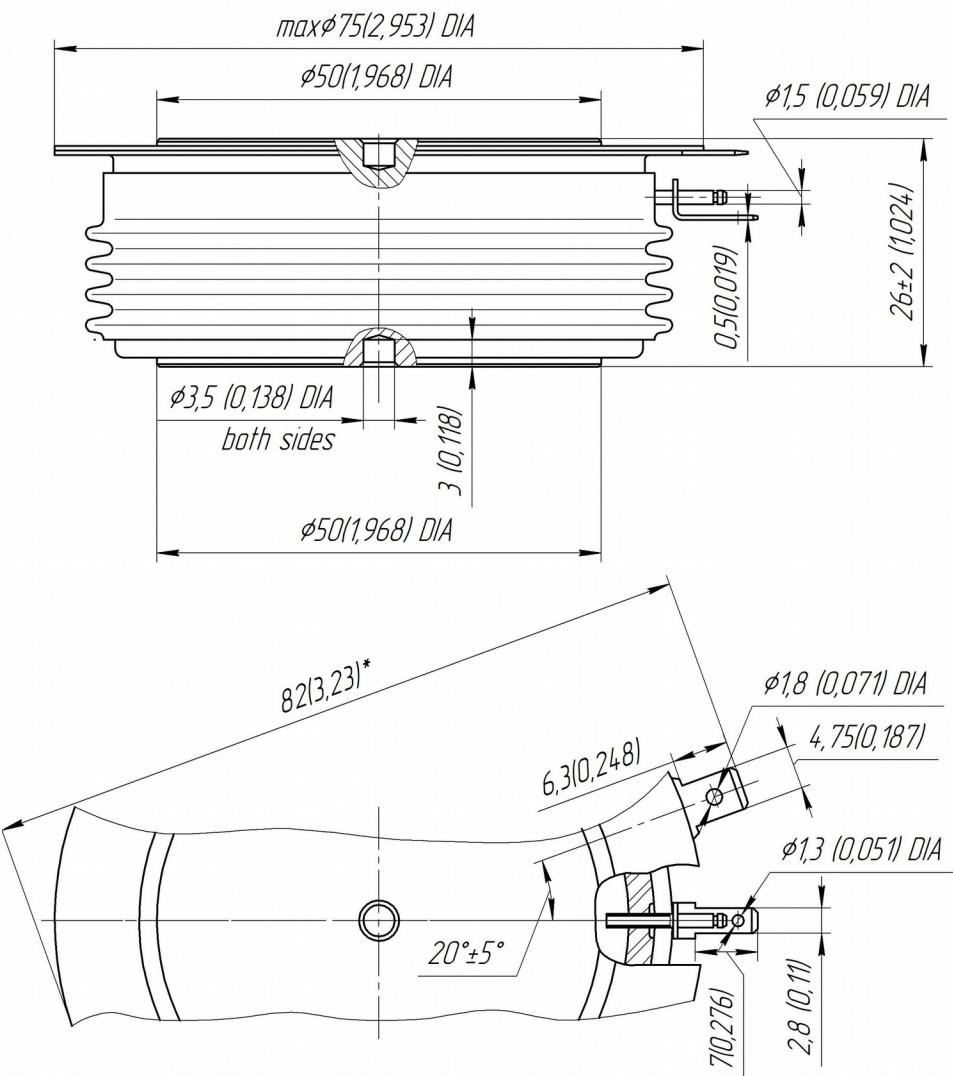
  

MECHANICAL						
W	Weight, max		g	510		
$D_s$	Surface creepage distance		mm (inch)	30.38 (1.196)		
$D_a$	Air strike distance		mm (inch)	18.05 (0.710)		

PART NUMBERING GUIDE							NOTES																							
T	153	800	18	A2	E2	N																								
1	2	3	4	5	6	7																								
1. Phase Control Thyristor							1) Critical rate of rise of off-state voltage																							
2. Design version							<table border="1"> <thead> <tr> <th>Symbol of Group (<math>\text{dv}_o/\text{dt}_{\text{crit}}</math>, V/<math>\mu\text{s}</math>)</th><th>P2</th><th>K2</th><th>E2</th><th>A2</th><th>T1</th><th>P1</th><th>M1</th></tr> </thead> <tbody> <tr> <td>200</td><td>320</td><td>500</td><td>1000</td><td>1600</td><td>2000</td><td>2500</td><td></td></tr> </tbody> </table>								Symbol of Group ( $\text{dv}_o/\text{dt}_{\text{crit}}$ , V/ $\mu\text{s}$ )	P2	K2	E2	A2	T1	P1	M1	200	320	500	1000	1600	2000	2500	
Symbol of Group ( $\text{dv}_o/\text{dt}_{\text{crit}}$ , V/ $\mu\text{s}$ )	P2	K2	E2	A2	T1	P1	M1																							
200	320	500	1000	1600	2000	2500																								
3. Mean on-state current, A							2) Turn-off time ( $\text{dv}_D/\text{dt}=50 \text{ V}/\mu\text{s}$ )																							
4. Voltage code							<table border="1"> <thead> <tr> <th>Symbol of Group <math>t_{\text{tr}}, \mu\text{s}</math></th><th>P2</th><th>M2</th><th>K2</th><th>H2</th><th>E2</th></tr> </thead> <tbody> <tr> <td>200</td><td>250</td><td>320</td><td>400</td><td>500</td><td></td></tr> </tbody> </table>										Symbol of Group $t_{\text{tr}}, \mu\text{s}$	P2	M2	K2	H2	E2	200	250	320	400	500			
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6. Turn-off time ( $\text{dv}_D/\text{dt}=50 \text{ V}/\mu\text{s}$ )																														
7. Ambient conditions: N – normal; T – tropical																														

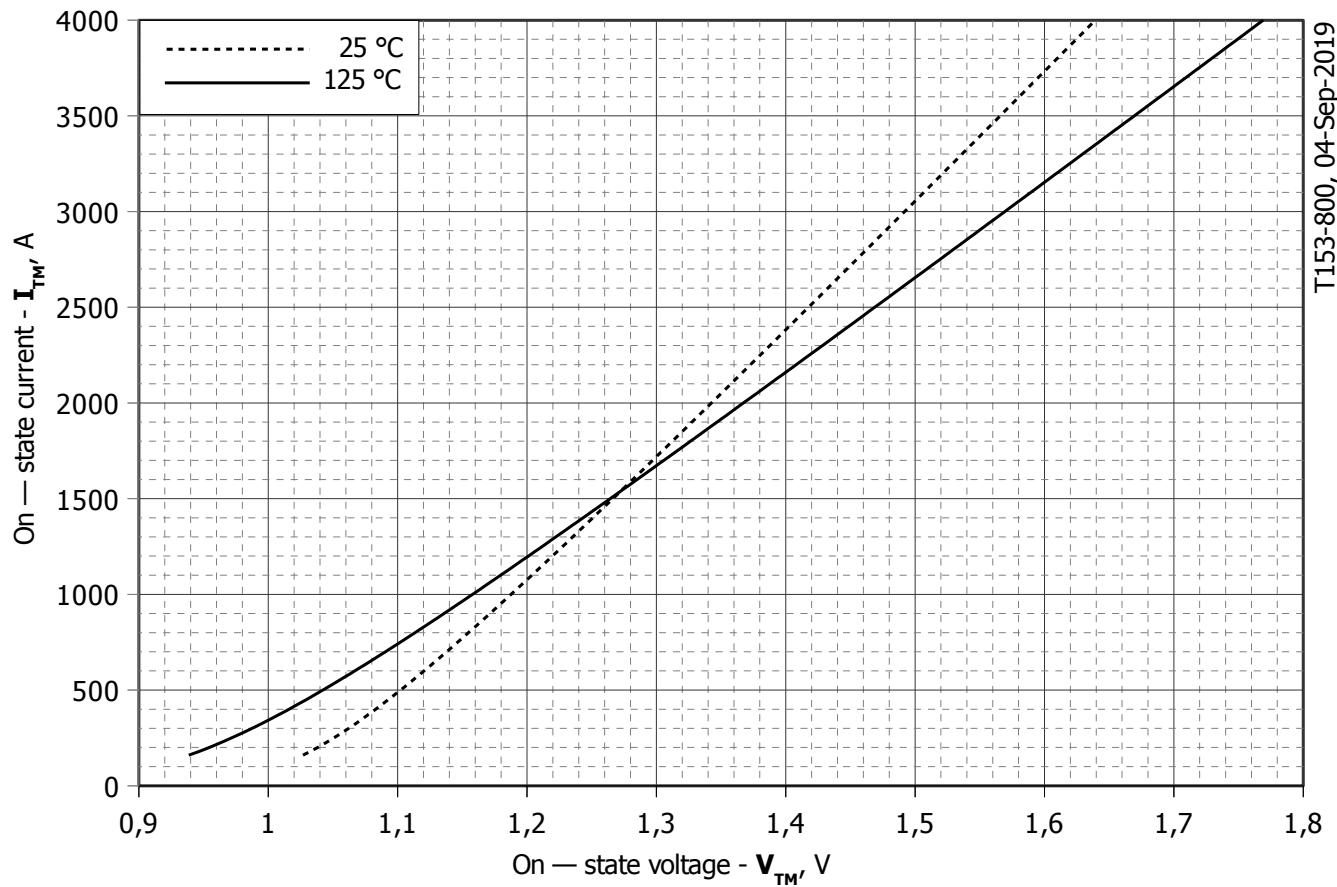
## OVERALL DIMENSIONS

Package type: T.D5



All dimensions in millimeters (inches)

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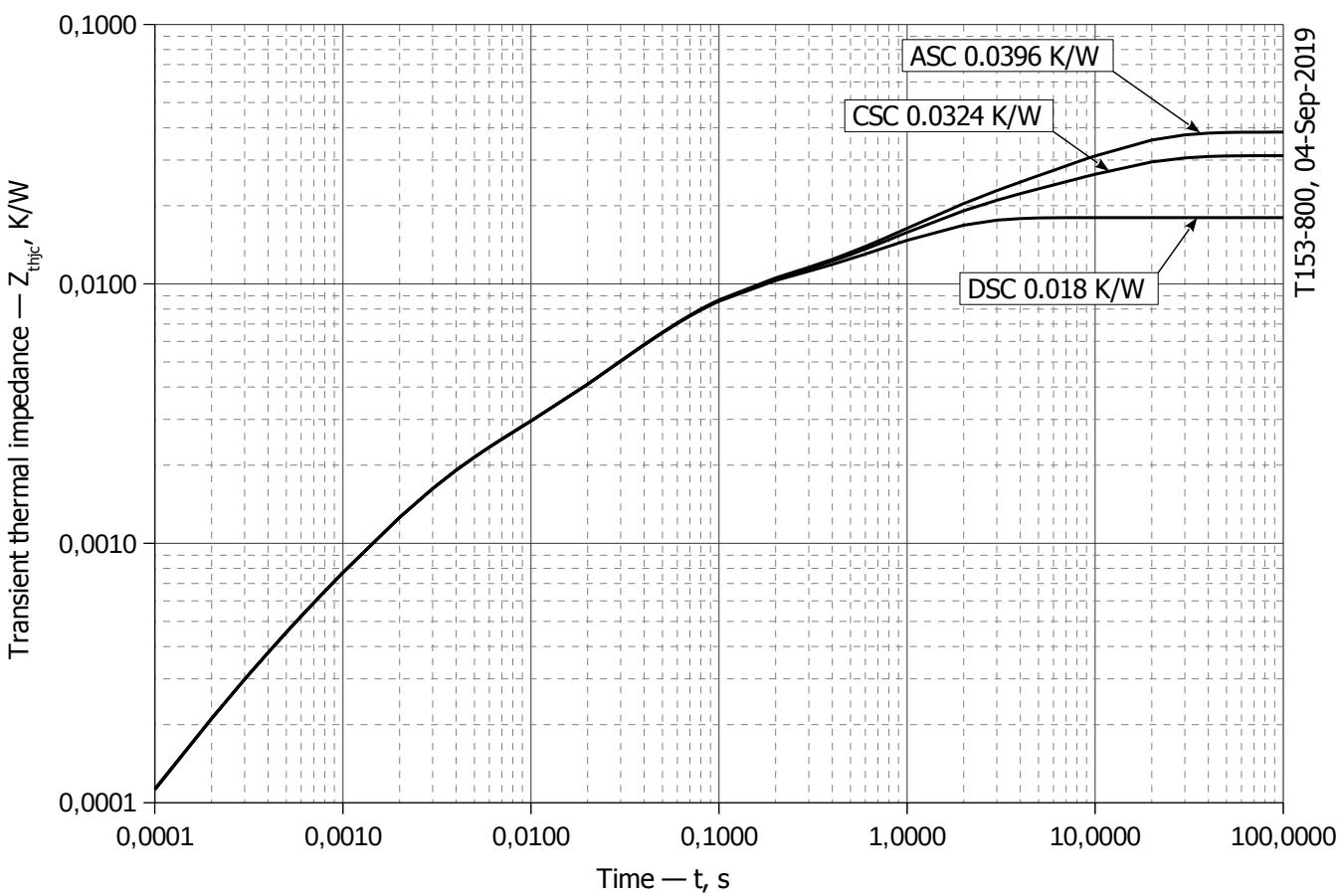
**Fig 1 – On-state characteristics of Limit device**

Analytical function for On-state characteristic:

$$V_T = A + B \cdot i_T + C \cdot \ln(i_T + 1) + D \cdot \sqrt{i_T}$$

	Coefficients for max curves	
	$T_j = 25^\circ\text{C}$	$T_j = T_{j,\max}$
<b>A</b>	0.85428000	0.6850000
<b>B</b>	0.00014815	0.0002042
<b>C</b>	0.03224500	0.0489070
<b>D</b>	-0.00118650	-0.0021869

**On-state characteristic model (see Fig. 1)**



**Fig 2 – Transient thermal impedance  $Z_{thjc}$  vs. time  $t$**

Analytical function for Transient thermal impedance junction to case  $Z_{thjc}$  for DC:

$$Z_{thjc} = \sum_{i=1}^n R_i \left( 1 - e^{-\frac{t}{\tau_i}} \right)$$

Where  $i = 1$  to  $n$ ,  $n$  is the number of terms in the series.

$t$  = Duration of heating pulse in seconds.

$Z_{thjc}$  = Thermal resistance at time  $t$ .

$R_i$  = Amplitude of  $p_{th}$  term.

$\tau_i$  = Time constant of  $r_{th}$  term.

DC Double side cooled

i	1	2	3	4	5	6
$R_i$ , K/W	0.009241	0.006037	0.001231	0.001054	0.0003396	0.00009575
$\tau_i$ , s	0.9673	0.04967	0.002733	0.07734	0.001638	0.0002248

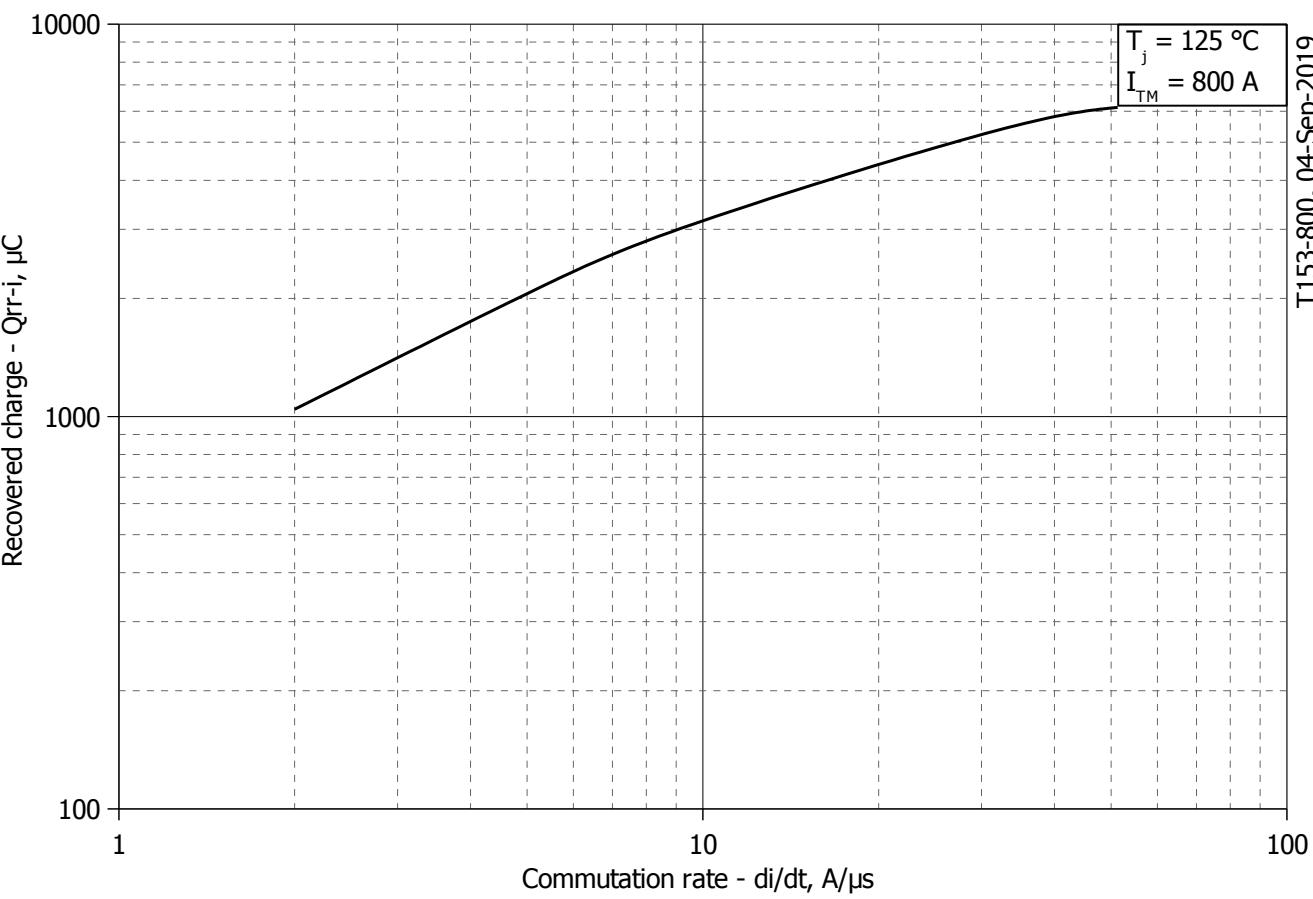
DC Anode side cooled

i	1	2	3	4	5	6
$R_i$ , K/W	0.01318	0.009281	0.006055	0.001018	0.001535	0.0001182
$\tau_i$ , s	9.745	1.028	0.05591	0.03732	0.002468	0.0002687

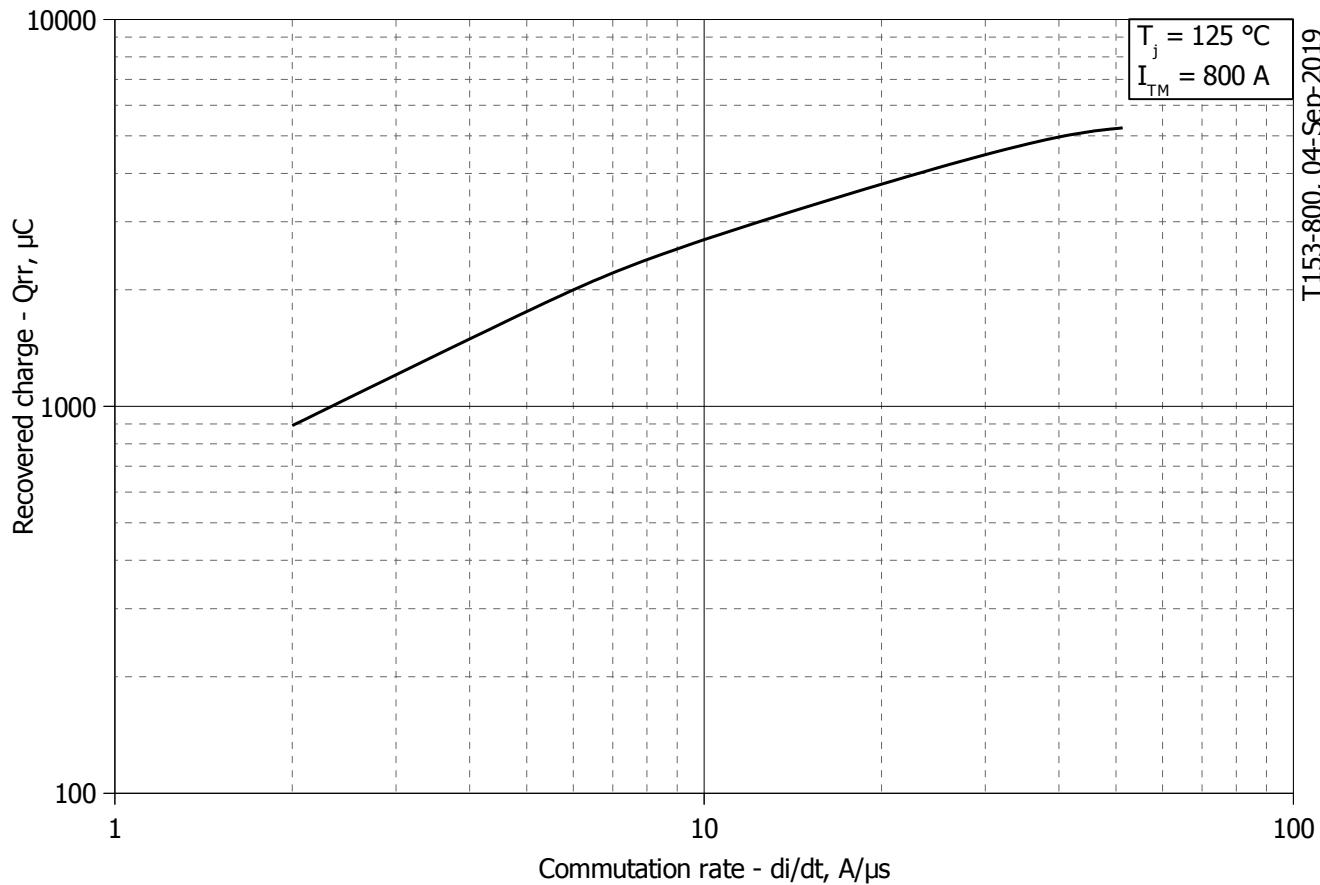
DC Cathode side cooled

i	1	2	3	4	5	6
$R_i$ , K/W	0.02041	0.009325	0.006949	0.0001252	0.001516	0.0001119
$\tau_i$ , s	9.752	1.065	0.05344	0.01407	0.002421	0.0002554

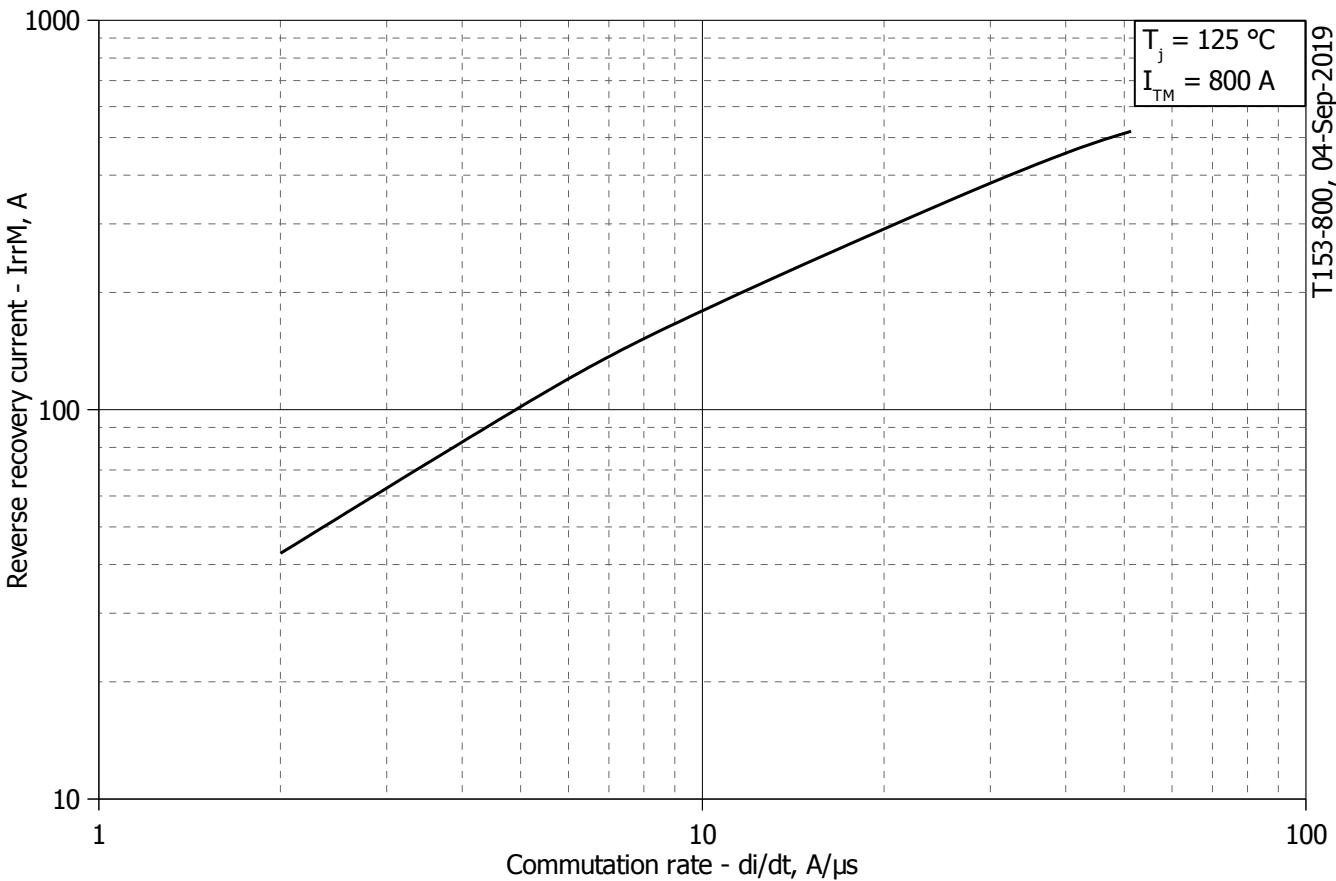
**Transient thermal impedance junction to case  $Z_{thjc}$  model (see Fig. 2)**



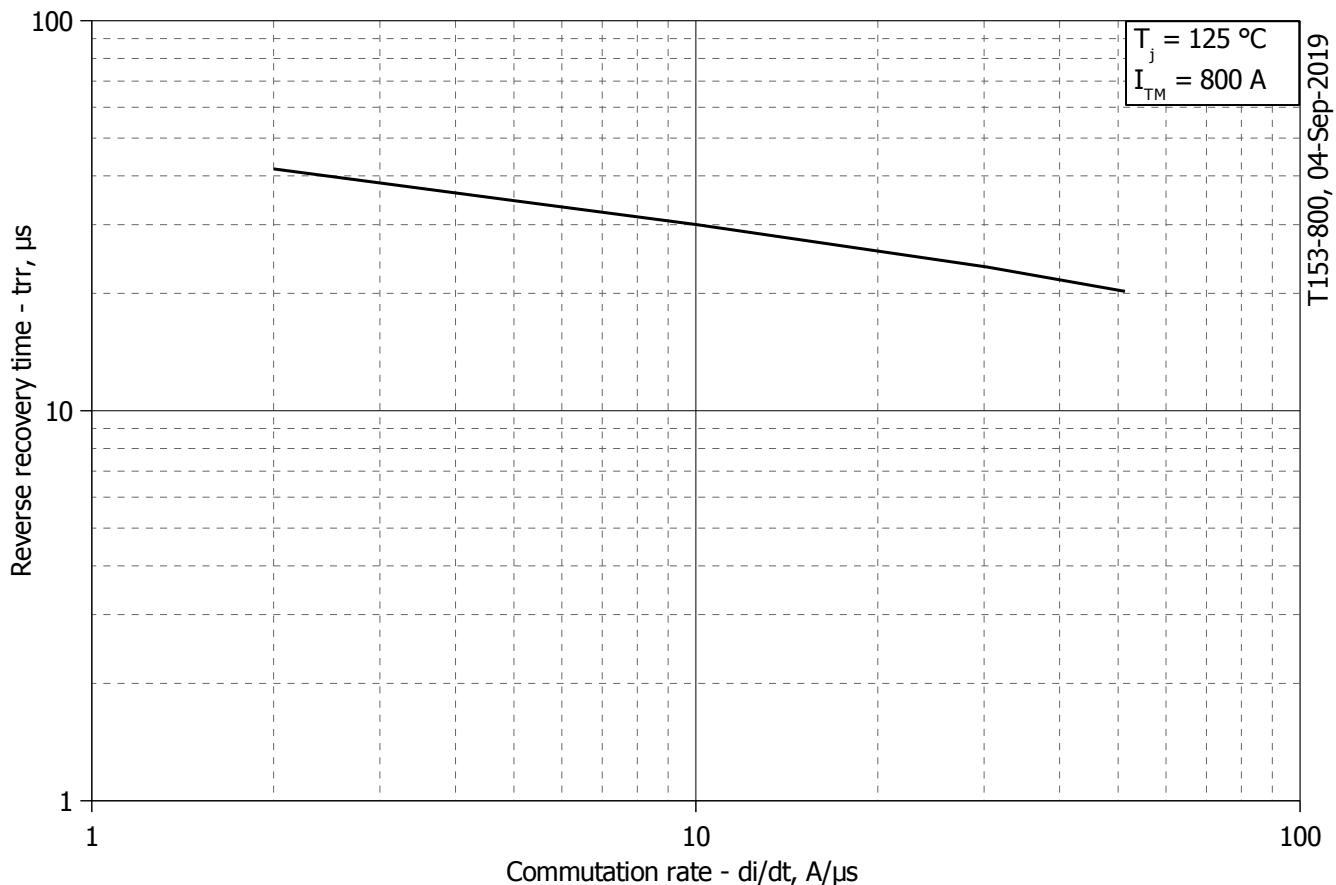
**Fig 3 – Maximum recovered charge  $Q_{rr-i}$  (integral) vs. commutation rate  $di_R/dt$**



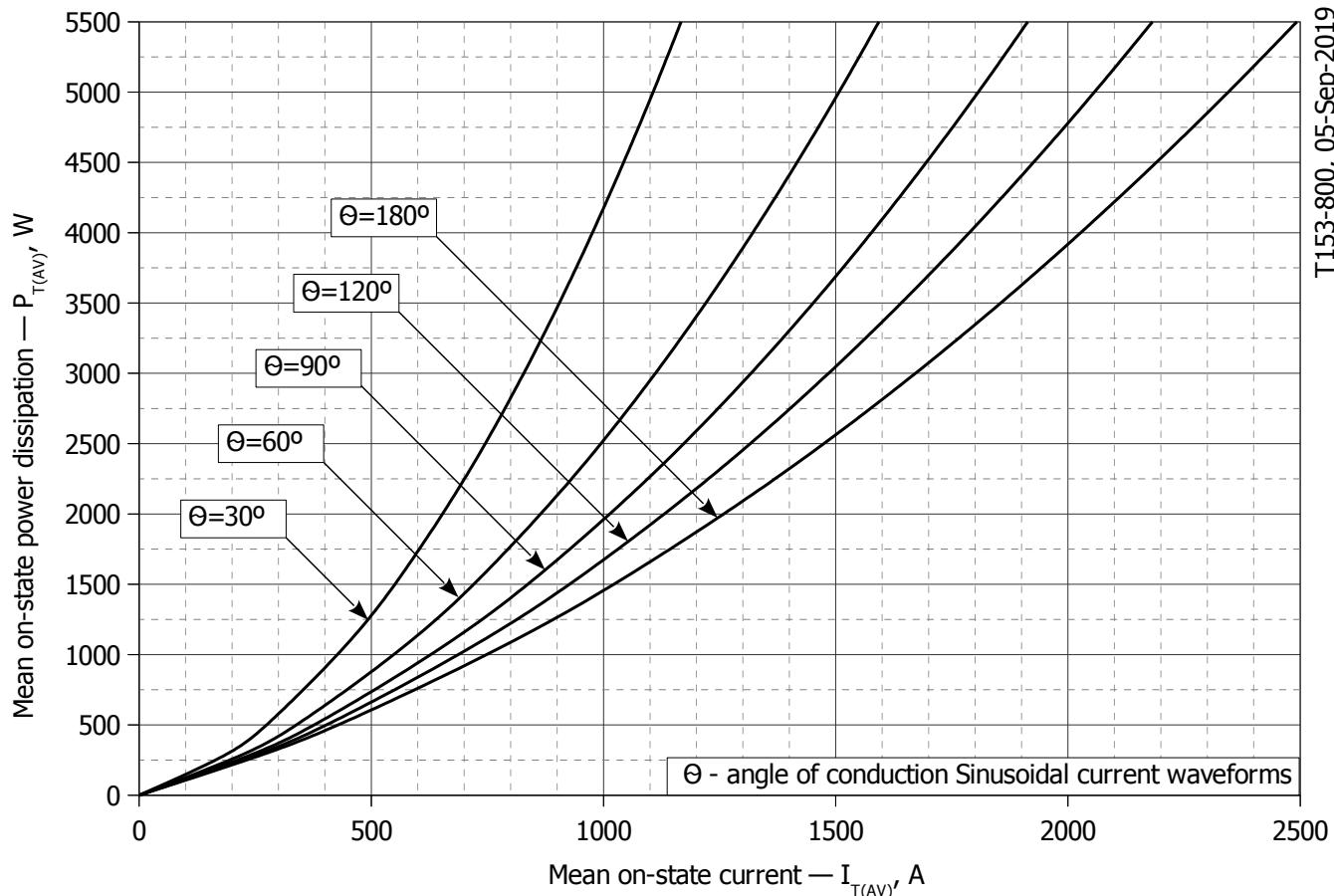
**Fig 4 – Maximum recovered charge  $Q_{rr}$  vs. commutation rate  $di_R/dt$  (25% chord)**



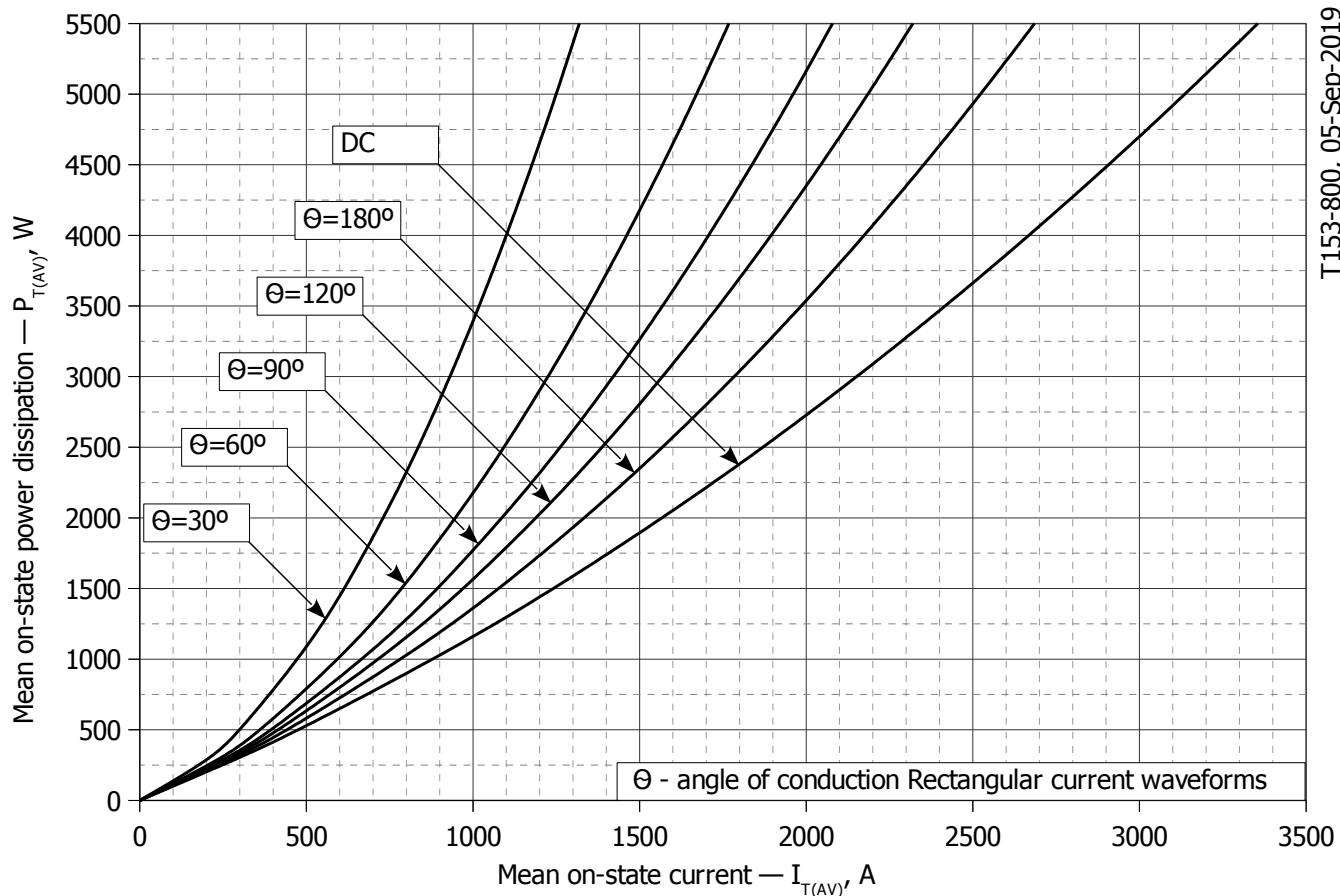
**Fig 5 – Maximum reverse recovery current  $I_{rrM}$  vs. commutation rate  $di_R/dt$**



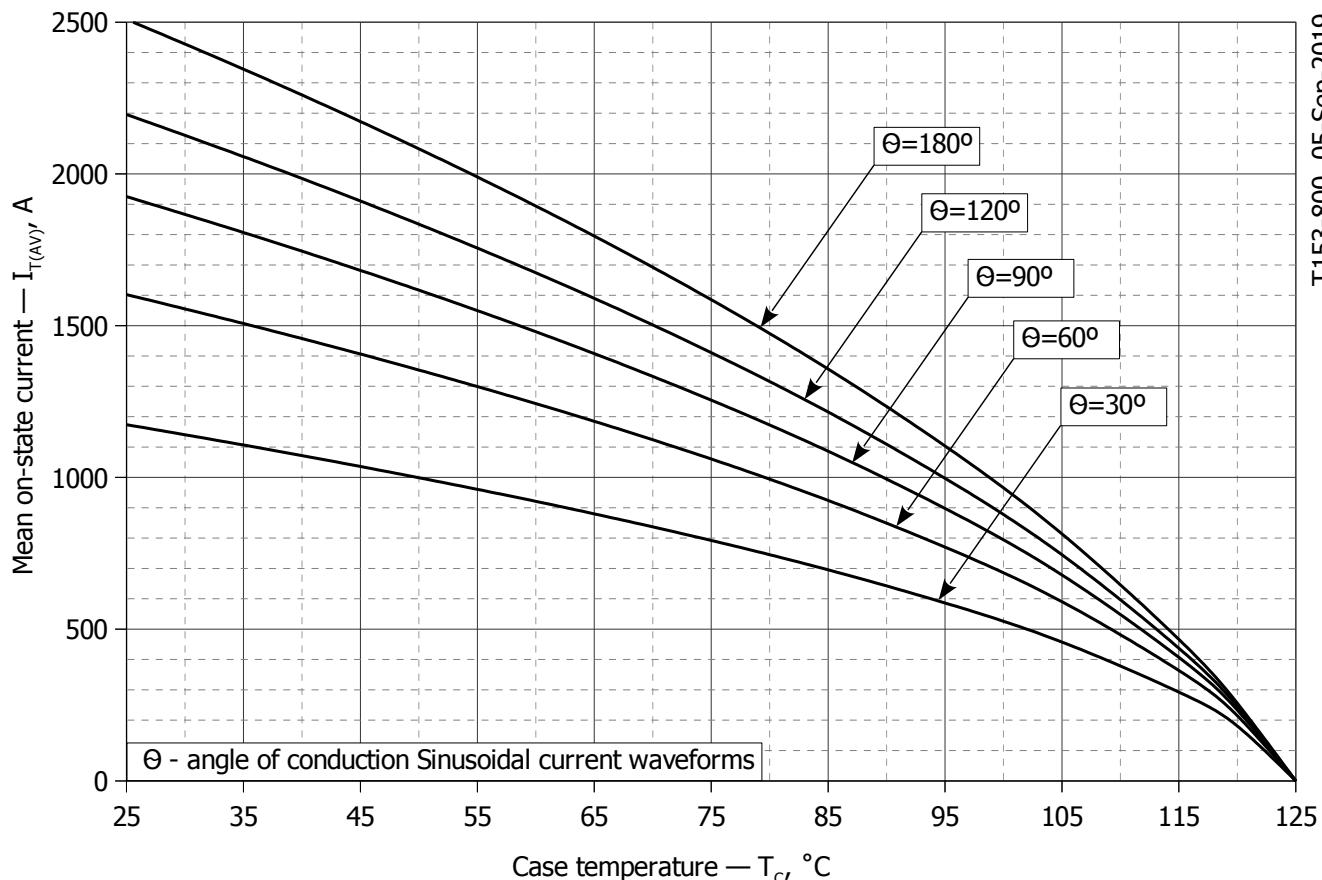
**Fig 6 – Maximum recovery time  $t_{rr}$  vs. commutation rate  $di_R/dt$  (25% chord)**



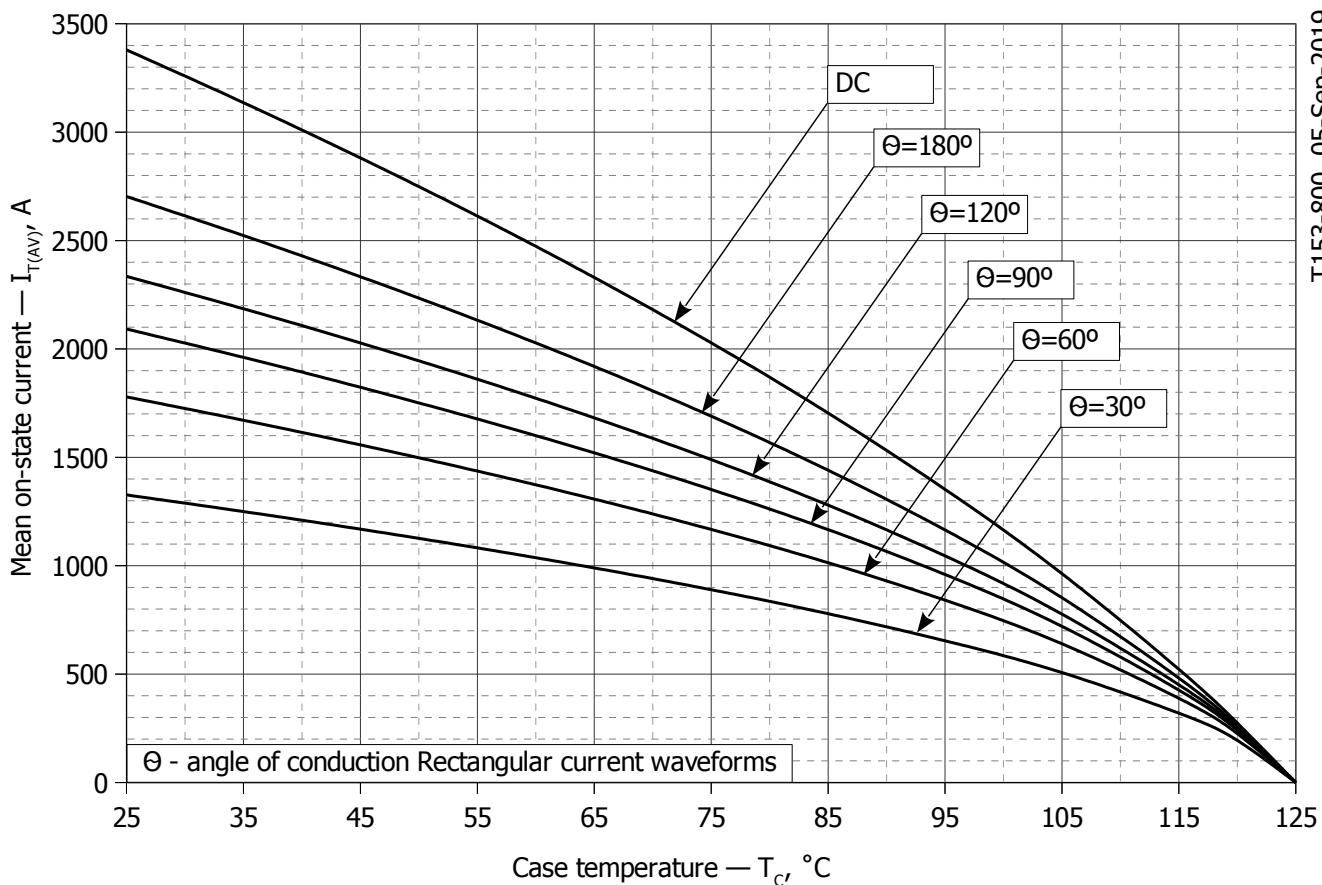
**Fig. 7 - Mean on-state power dissipation  $P_{TAV}$  vs. mean on-state current  $I_{TAV}$  for sinusoidal current waveforms at different conduction angles (f=50Hz, DSC)**



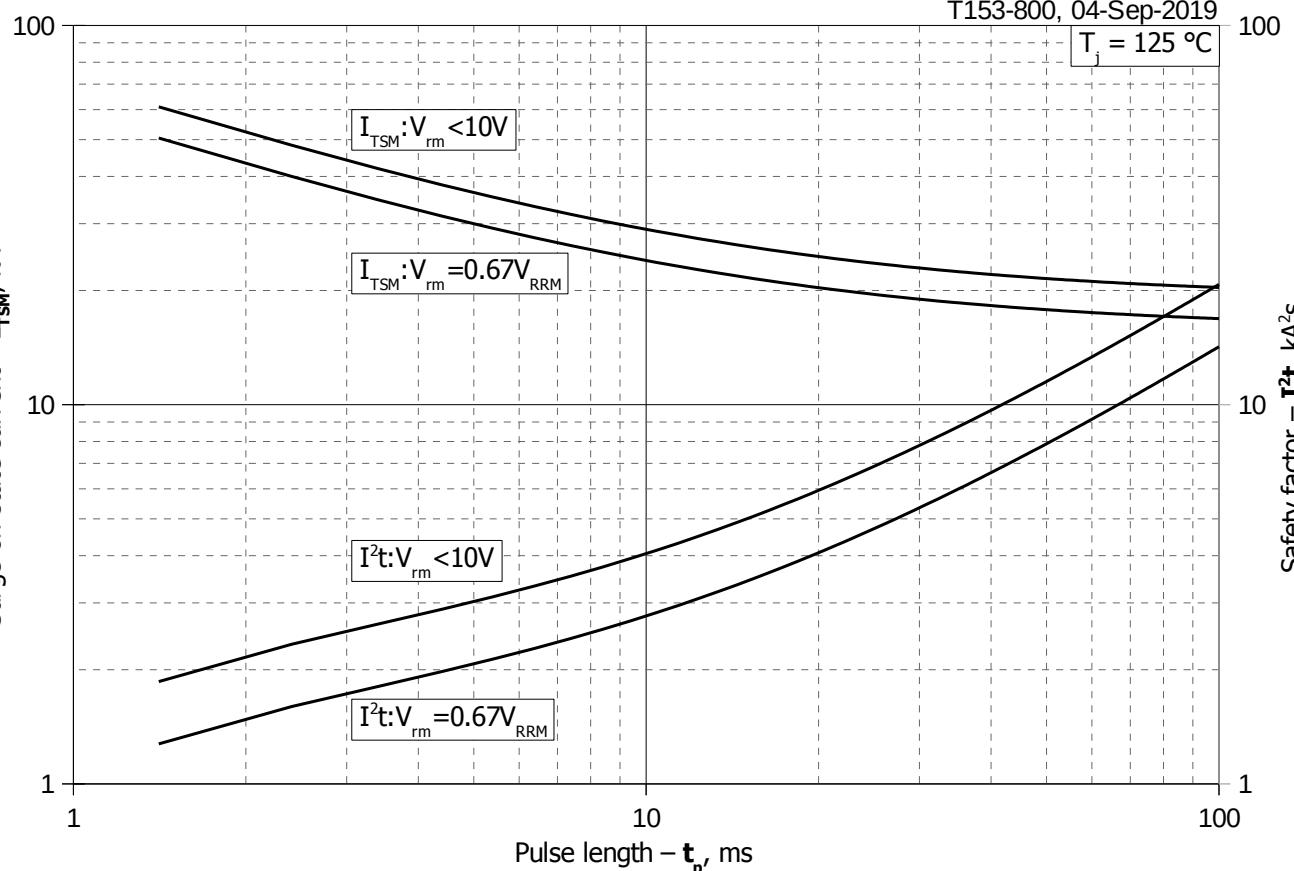
**Fig. 8 – Mean on-state power dissipation  $P_{TAV}$  vs. mean on-state current  $I_{TAV}$  for rectangular current waveforms at different conduction angles and for DC (f=50Hz, DSC)**



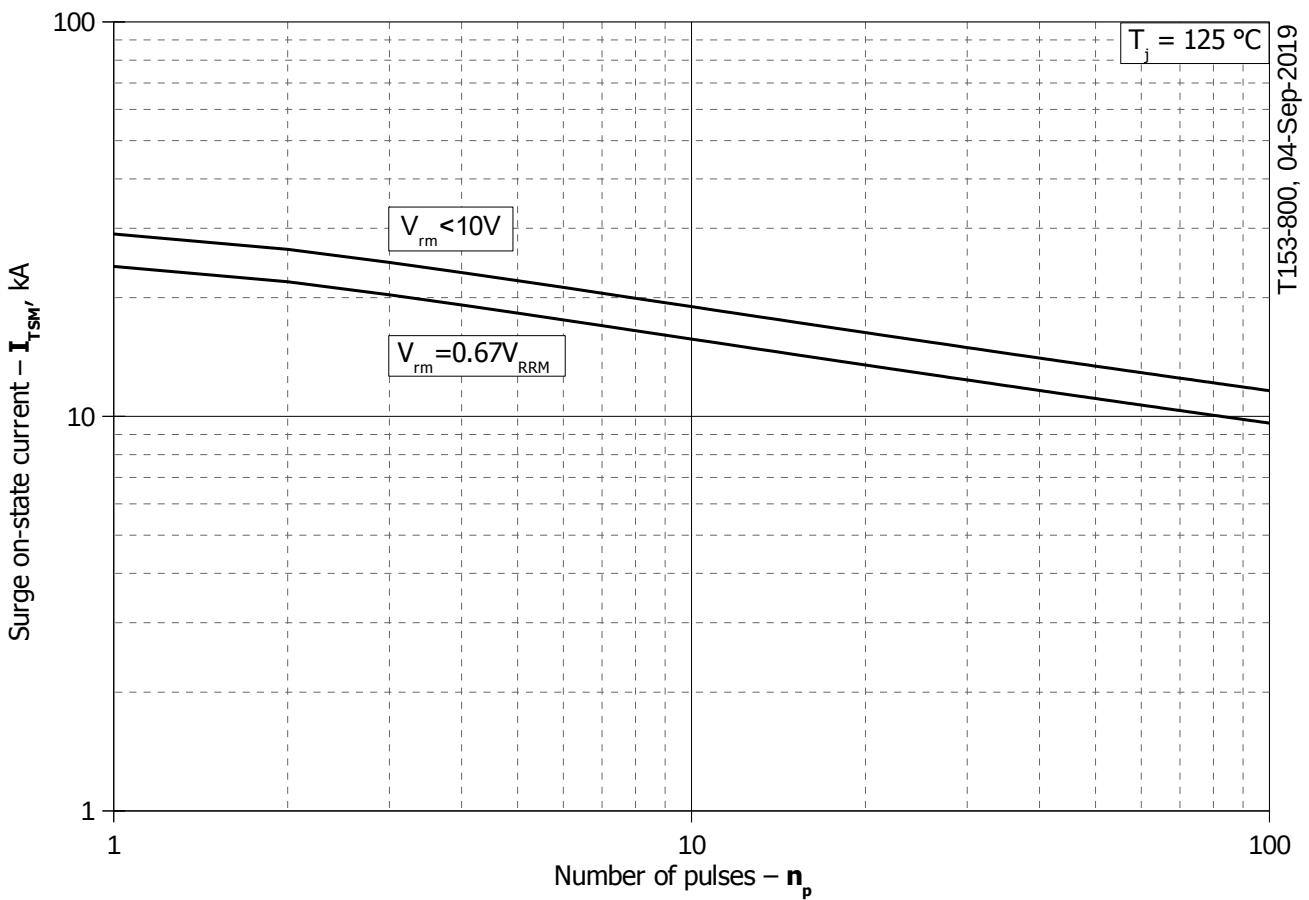
**Fig. 9 – Mean on-state current  $I_{TAV}$  vs. case temperature  $T_c$  for sinusoidal current waveforms at different conduction angles (f=50Hz, DSC)**



**Fig. 10 - Mean on-state current  $I_{TAV}$  vs. case temperature  $T_c$  for rectangular current waveforms at different conduction angles and for DC (f=50Hz, DSC)**



**Fig. 11 – Maximum surge on-state current  $I_{TSM}$  and safety factor  $I^2t$  vs. pulse length  $t_p$**



**Fig. 12 - Maximum surge on-state current  $I_{TSM}$  vs. number of pulses  $n_p$**